

DOCKET NO.: MERCHANT 33-3-3



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Sailesh Merchant, et al.

Serial No.: 09/092,158

Filed: June 6, 1998

For: METHOD FOR THE FABRICATION OF CONTACTS IN AN INTEGRATED CIRCUIT DEVICE

Group No.: 2823

Examiner: Eaton, K.

Commissioner of Patents
and Trademarks
Washington, D.C. 20231

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on 3/28/00 (Date)
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Sir:

AMENDMENT UNDER 37 C.F.R. § 1.111

In response to the Examiner's Action mailed December 28, 1999, please amend the above-identified application as follows:

IN THE SPECIFICATION:

On page 8, line 15 after "process.", insert as a new paragraph In another embodiment,
the method further includes forming an active device on a semiconductor substrate, forming a contact opening in a dielectric deposited on the active device wherein the contact opening is in electrical contact with the active device, depositing a barrier layer in the contact opening and on at least a portion of the semiconductor substrate, depositing a contact metal on the barrier layer

Al.
cont

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